# **Special Issue**

# Implantable Biocompatible Alloys Devices and Application

## Message from the Guest Editors

The Special Issue "Implantable Biocompatible Alloys Devices and Application" will mainly cover the characterization of biocompatible materials focusing on the relevant or innovative medical applications of such an approach. In particular, the topics of interest include, but are not limited to:

- Obtaining of all types of biomaterials used for medical applications: metallic, ceramics, polymers, composites;
- Mechanical coating/alloying/treatment of the metallic and non-metallic materials;
- Thermo/chemical treatment of the metallic and nonmetallic materials.

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## Deadline for manuscript submissions

closed (30 December 2022)



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#### Editor-in-Chief

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